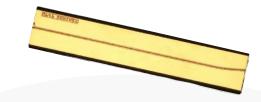
High Power SOA Chip



Part Number: CHP-285

High Power SOA Chip Single-Mode SOA Fabry-Perot Wavelength at 1550nm



Features

- High Output Power
- High Dynamic Range
- High Efficiency
- Standard SOA Bare Die
- Cost Effective

Application

- OTDR
- Lidar
- Free Space Communications
- Network Test Equipment



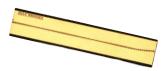
SemiNex delivers the highest available power at infrared wavelengths between 12xx and 19xx nm. When necessary, we will further optimize the design of our InP & GaSb laser chips to meet our customers' specific optical and electrical performance needs. Diodes, bars and packages are tested to meet customer and market performance demands. Typical results and packaging options are shown. Contact SemiNex for additional details or to discuss your specific requirements.

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Specification

CHP-285



Optical	Symbol	Тур.	Units
Center Wavelength	λ _c	1550	nm
Output Power @1A*	Pout	0.39	watts (±10%)
Aperture Width	AW	4	μm
Aperture Height	AH	1	μm
Gain @ Pin = 10μW	G	25	dB
Beam Exit Angle	θ_{ext}	19.5	Degree
Noise Figure	NF	5	dB
Polarization Extinction Ratio	PER	18	dB
Fast Axis Div.	ΘŤ	30	Deg FWHM
Slow Axis Div.	Θ	20	Deg FWHM
Front Facet Reflectivity		<0.1%	
Rear Face Reflectivity		<0.1%	
Waveguide		Curved	
Electrical	Symbol		Units
Operating Current	lop	1	А
Operating Voltage	V _{op}	2	V
Mechanical		Range	Units
Chip Length		2500	μm
Chip Width		500	μm
Operating Temp.**		-20 to 75	°C
Storage Temp.		-40 to 85	°C

*Optical Power for 1310nm Chips CHP-288 and CHP-290 has an SOA current @ 1.2A and Pin @ 7mW *Optical Power for 1550nm Chips CHP-285 and CHP-287 has an SOA current @ 1.4A and Pin @ 36mW

*Specified values are rated at a constant heat sink temperature of 20°C.

**High temperature operation will reduce performance and MTTF.

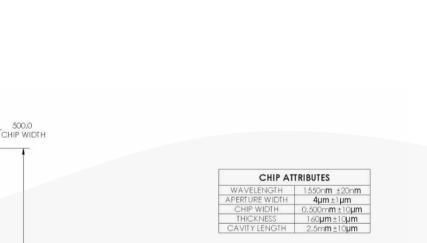
Unless otherwise indicated all values are nominal.

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Mechanical Drawing

LASER RIDGE, PLANAR WITH TOP SURFACE



P-METAL				
MATERIAL	THICKNESS (nm)	TOLERANCE (nm)		
Ti	50	±10		
Pt	125	±25		
Au	250	±50		

N-METAL				
MATERIAL	THICKNESS (nm)	TOLERANCE (nm)		
Ti	30	±10		
Pt	125	±25		
Au	400	±40		

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CAVITY



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- 0.0 P-SIDE FULLY METALIZED SURFACE - 160.0 N-SIDE FULLY METALIZED SURFACE